

OKI Semiconductor

MR26V25605J

8M-Word × 32-Bit or 16M-Word × 16-Bit P2ROM

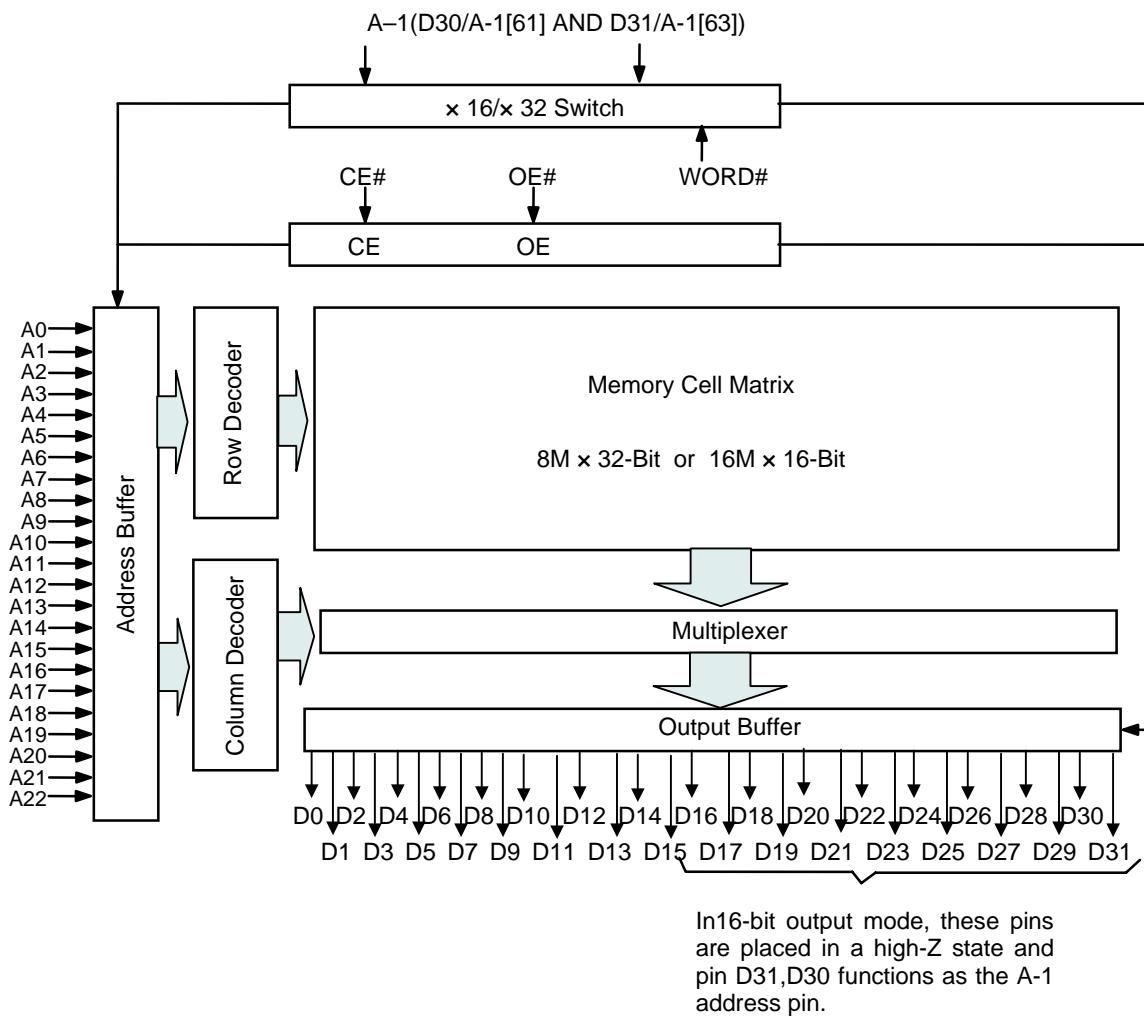
FEATURES

- 8,388,608-word × 32-bit/16,777,216-word × 16-bit electrically switchable configuration
- 3.0 V to 3.6 V power supply
- Access time 90 ns MAX
- Operating current 60 mA MAX
- Standby current 50 µA MAX
- Input/Output TTL compatible
- Three-state output

PACKAGES

- MR26V25605J-xxxMB
70-pin plastic SSOP (P-SSOP70-500-0.80-K-MC)

PIN CONFIGURATION (TOP VIEW)	
A0 [1]	○
A1 [2]	70 A22
A2 [3]	69 A21
A3 [4]	68 A20
A4 [5]	67 WORD#
A5 [6]	66 OE#
Vcc [7]	65 CE#
D0 [8]	64 Vss
D16 [9]	63 D31/A-1
D17 [10]	62 D15
Vss [11]	61 D30/A-1
Vcc [12]	60 D14
Vcc [13]	59 Vss
D2 [14]	58 Vcc
D18 [15]	57 D29
D3 [16]	56 D13
D19 [17]	55 D28
D4 [18]	54 D12
D20 [19]	53 D27
D5 [20]	52 D11
D21 [21]	51 D26
Vss [22]	50 D10
Vcc [23]	49 Vss
D6 [24]	48 Vcc
D22 [25]	47 D25
D7 [26]	46 D9
D23 [27]	45 D24
Vss [28]	44 D8
A6 [29]	43 Vcc
A7 [30]	42 A19
A8 [31]	41 A18
A9 [32]	40 A17
A10 [33]	39 A16
A11 [34]	38 A15
A12 [35]	37 A14
	36 A13

BLOCK DIAGRAM**PIN DESCRIPTIONS**

Pin name	Functions
D31 / A-1, D30/A-1	Data output / Address input
A0 to A22	Address inputs
D0 to D29	Data outputs
CE#	Chip enable input
OE#	Output enable input
WORD#	Double word - Word select input
V _{cc}	Power supply voltage
V _{ss}	Ground

FUNCTION TABLE

Mode	CE#	OE#	WORD#	V _{CC}	D0 to D15	D16 to D29	D30/A-1,D31/A-1	
Read (32-Bit)	L	L	H	3.3 V	D _{OUT}			
Read (16Bit)	L	L	L		D _{OUT}	Hi-Z	L/H	
Output disable	L	H	H		Hi-Z		*	
			L		Hi-Z		*	
Standby	H	*	H		Hi-Z		*	
			L		Hi-Z		*	

*: Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	T _a	—	0 to 70	°C
Storage temperature	T _{stg}	—	-55 to 125	°C
Input voltage	V _I	relative to V _{SS}	-0.5 to V _{CC} +0.5	V
	V _O		-0.5 to V _{CC} +0.5	V
	V _{CC}		-0.5 to 5	V
	P _D	T _a = 25°C	1.0	W
Output short circuit current	I _{OS}	—	10	mA

RECOMMENDED OPERATING CONDITIONS

(T _a = 0 to 70°C)						
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V _{CC} power supply voltage	V _{CC}	V _{CC} = 3.0 to 3.6 V	3.0	—	3.6	V
Input "H" level	V _{IH}		2.2	—	V _{CC} +0.5*	V
Input "L" level	V _{IL}		-0.5**	—	0.6	V

Voltage is relative to V_{SS}.*: V_{CC}+1.5V(Max.) when pulse width of overshoot is less than 10ns.

**: -1.5V(Min.) when pulse width of undershoot is less than 10ns.

PIN CAPACITANCE

(V _{CC} = 3.3 V, T _a = 25°C, f = 1 MHz)						
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C _{IN1}	V _I = 0 V	—	—	30	pF
WORD#	C _{IN2}		—	—	400	
Output	C _{OUT}		V _O = 0 V	—	20	

ELECTRICAL CHARACTERISTICS**DC Characteristics**(V_{CC} = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
Input leakage current	I _{LI}	V _I = 0 to V _{CC}		—	—	20	μA
Output leakage current	I _{LO}	V _O = 0 to V _{CC}		—	—	20	μA
V _{CC} power supply current (Standby)	I _{CCSC}	CE# = V _{CC}		—	—	50	μA
	I _{CCST}	CE# = V _{IH}		—	—	1	mA
V _{CC} power supply current (Read)	I _{CCA1}	Ce# = V _{IL} OE# = V _{IL}	t _c = 90 ns	—	—	60	mA
Input "H" level	V _{IH}	—		2.2	—	V _{CC} +0.5*	V
Input "L" level	V _{IL}	—		-0.5**	—	0.6	V
Output "H" level	V _{OH}	I _{OH} = -2 mA		2.4	—	—	V
Output "L" level	V _{OL}	I _{OL} = 2 mA		—	—	0.4	V

Voltage is relative to V_{SS}.* : V_{CC}+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : -1.5V(Min.) when pulse width of undershoot is less than 10ns.

AC Characteristics(V_{CC} = 3.3 V ± 0.3 V, Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t _C	—	90	—	ns
Address access time	t _{ACC}	Ce# = OE# = V _{IL}	—	90	ns
CE# access time	t _{CE}	OE# = V _{IL}	—	90	ns
OE# access time	t _{OE}	Ce# = V _{IL}	—	40	ns
Output disable time	t _{CHZ}	OE# = V _{IL}	0	20	ns
	t _{OHZ}	Ce# = V _{IL}	0	20	ns
Output hold time	t _{OH}	Ce# = OE# = V _{IL}	0	—	ns

Measurement conditions

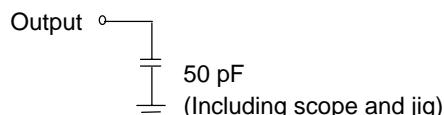
Input signal level ----- 0 V/3 V

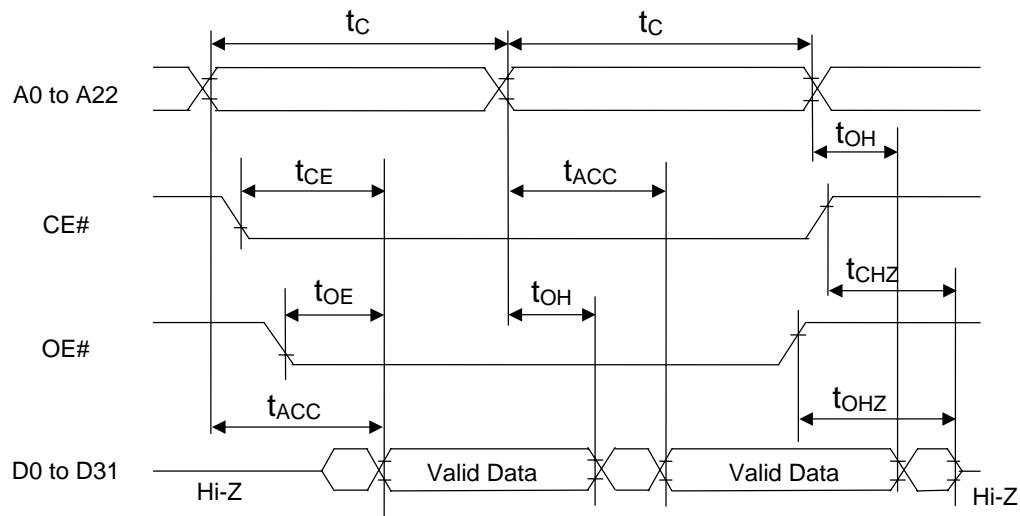
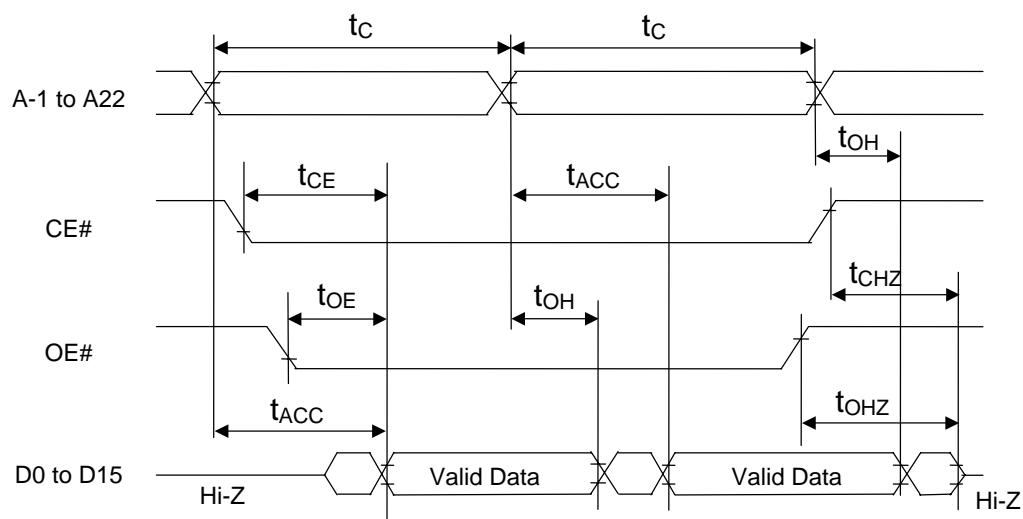
Input timing reference level----- 1/2V_{CC}

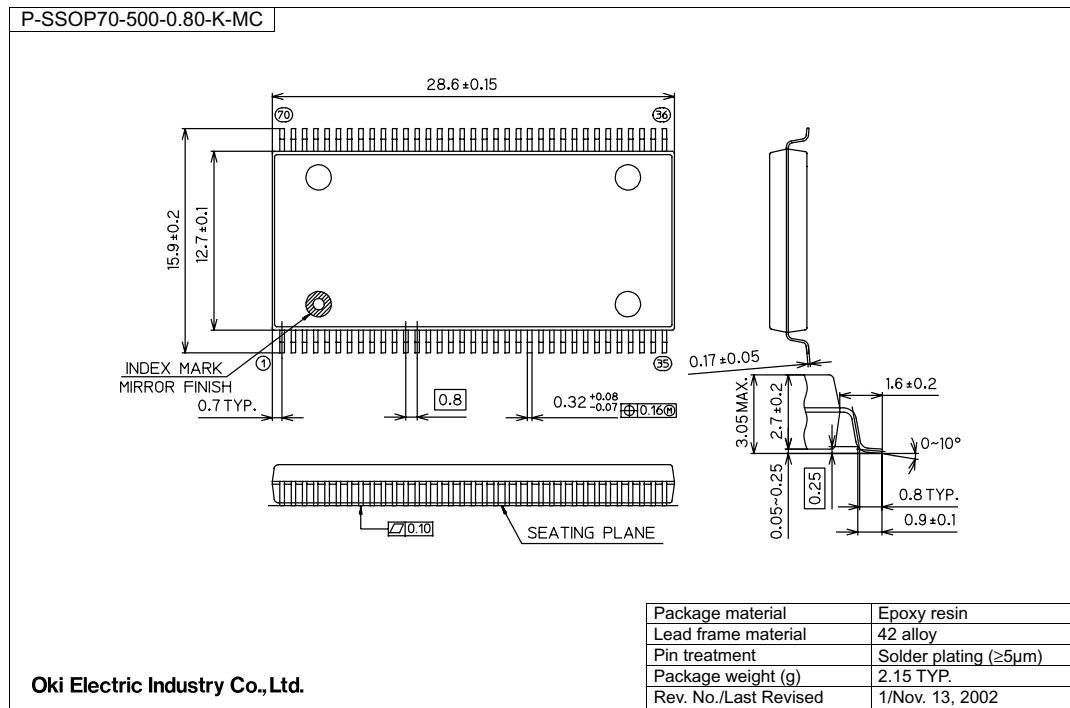
Output load----- 50 pF

Output timing reference level----- 1/2V_{CC}

Output load



TIMING CHART (READ CYCLE)**32-Bit Read Mode (WORD# = V_{IH})****16-Bit Read Mode (WORD# = V_{IL})**



(Unit: mm)

Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

REVISION HISTORY

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDR26V25605J-02-01	Nov., 2002	–	–	Final edition 1
FEDR26V25605J-02-02	Jul. 31, 2003	4	4	Change tCHZ, tOHZ to 20ns
FEDR26V25605J-02-03	Jul. 9, 2004	3	3	Add PD condition and I _{OS} = 10mA

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